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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

PIC16(L)F19155/56/75/76/85/86

Full-Featured 28/40/44/48-Pin Microcontrollers

Description

PIC16(L)F19155/56/75/76/85/86 microcontrollers offer eXtreme Low-Power (XLP) LCD drive coupled with Core Independent Peripherals (CIPs) and Intelligent Analog. They are especially suited for battery-powered LCD applications due to an integrated charge pump, high current I/O drive for backlighting, and battery backup of the Real-Time Clock/Calendar (RTCC). Active clock tuning of the HFINTOSC provides a highly accurate clock source over voltage and temperature. The family also features a new 12-bit ADC controller which can automate Capacitive Voltage Divider (CVD) techniques for advanced touch sensing, averaging, filtering, oversampling and automatic threshold comparison. Other new features include low-power IDLE and DOZE modes, Device Information Area (DIA), and Memory Access Partition (MAP). These low-power products are available in 28/40/44 and 48 pins to support the customer in various LCD and general purpose applications.

Core Features

- C Compiler Optimized RISC Architecture
- Operating Speed:
  - DC – 32 MHz clock input
  - 125 ns minimum instruction cycle
- Interrupt Capability
- 16-Level Deep Hardware Stack
- Timers:
  - Two 8-bit (TMR2/4) Timer with Hardware Limit Timer Extension (HLT)
  - 16-bit (TMR0/1)
- Low-Current Power-on Reset (POR)
- Configurable Power-up Timer (PWRTE)
- Brown-out Reset (BOR) with Fast Recovery
- Low-Power BOR (LPBOR) Option
- Windowed Watchdog Timer (WWDT):
  - Variable prescaler selection
  - Variable window size selection
  - All sources configurable in hardware or software
- Programmable Code Protection

Memory

- Up to 16kW/28KB Flash Program Memory
- Up to 2KB Data SRAM Memory
- 256 bytes DataEE
- Direct, Indirect and Relative Addressing modes
- Memory Access Partition (MAP):
  - Bootloader write-protect
  - Custom partition
- Device Information Area (DIA):
  - Temp sensor factory calibrated data
  - Fixed Voltage Reference
  - Device ID

Operating Characteristics

- Operating Voltage Range:
  - 1.8V to 3.6V (PIC16LF19155/56/75/76/85/86)
  - 2.3V to 5.5V (PIC16F19155/56/75/76/85/86)
- Temperature Range:
  - Industrial: -40°C to 85°C
  - Extended: -40°C to 125°C

Power-Saving Functionality

- DOZE mode: Ability to run CPU core slower than the system clock
- IDLE mode: Ability to halt CPU core while internal peripherals continue operating
- Sleep mode: Lowest power consumption
- Peripheral Module Disable (PMD): Ability to disable hardware module to minimize power consumption of unused peripherals

eXtreme Low-Power (XLP) Features

- Sleep mode: 50 nA @ 1.8V, typical
- Watchdog Timer: 500 nA @ 1.8V, typical
- Secondary Oscillator: 500 nA @ 32 kHz
- Operating Current:
  - 8 µA @ 32 kHz, 1.8V, typical
  - 32 µA/MHz @ 1.8V, typical

Digital Peripherals

- LCD Controller:
  - Up to 248 segments
  - Charge pump for low-voltage operation
  - Contrast control
- Four Configurable Logic Cell Modules (CLC):
  - Integrated combinational and sequential logic

- Complementary Waveform Generator (CWG):
  - Rising and falling edge dead-band control
  - Full-bridge, half-bridge, 1-channel drive
    - Multiple signal sources
- Two Capture/Compare/PWM (CCP) module
- Two 10-Bit PWMs
- Peripheral Pin Select (PPS):
  - Enables pin mapping of digital I/O
- Communication:
  - Two EUSART, RS-232, RS-485, LIN compatible
  - One SPI/I^2C, SMBus, PMBus™ compatible
- Up to 43 I/O Pins:
  - Individually programmable pull-ups
  - Slew rate control
  - Interrupt-on-change with edge-select
  - Input level selection control (ST or TTL)
  - Digital open-drain enable

Analog Peripherals

- Analog-to-Digital Converter with Computation (ADC^2):
  - 12-bit with up to 39 external channels
  - Automates math functions on input signals: averaging, filter calculations, oversampling and threshold comparison
  - Conversion available during Sleep
- Two Comparators:
  - (1) Low-Power Clocked Comparator
  - (1) High-Speed Comparator
  - Fixed Voltage Reference at (non)inverting input(s)
  - Comparator outputs externally accessible
- 5-Bit Digital-to-Analog Converter (DAC):
  - 5-bit resolution, rail-to-rail
  - Positive Reference Selection
  - Unbuffered I/O pin output
  - Internal connections to ADCs and comparators
- Voltage Reference:
  - Fixed Voltage Reference with 1.024V, 2.048V and 4.096V output levels
- Zero-Cross Detect Module:
  - AC high-voltage zero-crossing detection for simplifying TRIAC control
  - Synchronized switching control and timing

Flexible Oscillator Structure

- High-Precision Internal Oscillator:
  - Active Clock Tuning of HFINTOSC over voltage and temperature (ACT)
  - Selectable frequency range up to 32 MHz ±1% typical
- x2/x4 PLL with Internal and External Sources
- Low-Power Internal 31 kHz Oscillator (LFINTOSC)
- External 32 kHz Crystal Oscillator (SOSC)
  - Oscillator Start-up Timer (OST)
  - Ensures stability of crystal oscillator source
- External Oscillator Block with:
  - Three external clock modes up to 32 MHz
- Fail-Safe Clock Monitor:
  - Allows for safe shutdown if peripherals clock stops

TABLE 1: PIC16(L)F191XX FAMILY TYPES

Device	Data Sheet Index	Program Flash Memory (kW/KB)	DataEE (bytes)	Data SRAM (bytes)	I/O Pins	12-bit ADC (ch)	5-bit DAC	Comparator	8-bit/ (with HLT) Timer	16-bit Timer	Window Watchdog Timer (WWDT)	CCP/10-bit PWM	CWG	CLC	Zero-Cross Detect	Temperature Indicator	Memory Access Partition	Device Information Area	EUSART/ I^2C/SPI	Peripheral Pin Select	Peripheral Module Disable	Debug(1)	LCD Segments (Max)	LCD Charge Pump/ Bias Generator
PIC16(L)F19155	(A)	8/14	256	1024	24	20	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	96	Y/Y
PIC16(L)F19156	(A)	16/28	256	2048	24	20	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	96	Y/Y
PIC16(L)F19175	(A)	8/14	256	1024	35	31	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	184	Y/Y
PIC16(L)F19176	(A)	16/28	256	2048	35	31	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	184	Y/Y
PIC16(L)F19185	(A)	8/14	256	1024	43	39	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	248	Y/Y
PIC16(L)F19186	(A)	16/28	256	2048	43	39	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	248	Y/Y
PIC16(L)F19195	(B)	8/14	256	1024	59	45	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	360	Y/Y
PIC16(L)F19196	(B)	16/28	256	2048	59	45	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	360	Y/Y
PIC16(L)F19197	(B)	32/56	256	4096	59	45	1	2	2	2	Y	2/2	1	4	Y	Y	Y	Y	2/1	Y	Y	I	360	Y/Y

Note 1: I – Debugging integrated on chip.

Data Sheet Index (Unshaded devices are described in this document):

A. Future Release PIC16(L)F19155/56/75/76/85/86 Data Sheet, 28/40/44/48-Pin

B. DS40001873 PIC16(L)F19195/6/7 Data Sheet, Full-Featured 64-Pin Microcontrollers

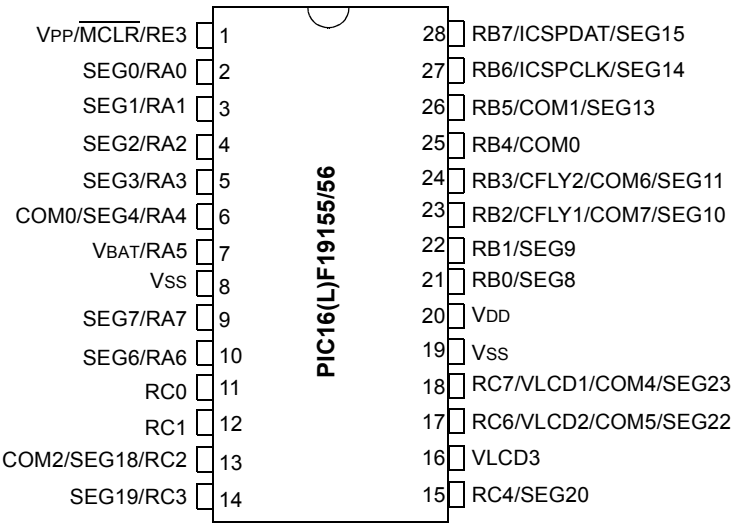
Note: For other small form-factor package availability and marking information, please visit www.microchip.com/packaging or contact your local sales office.

TABLE 2: PACKAGES

Device	28-Pin SPDIP	28-Pin SOIC	28-Pin SSOP	28-Pin UQFN (4x4)	40-Pin PDIP	40-Pin UQFN (5x5)	44-Pin TQFP	48-Pin UQFN (6x6)	48-Pin TQFP (7x7)
PIC16(L)F19155	X	X	X	X					
PIC16(L)F19156	X	X	X	X					
PIC16(L)F19175					X	X	X		
PIC16(L)F19176					X	X	X		
PIC16(L)F19185								X	X
PIC16(L)F19186								X	X

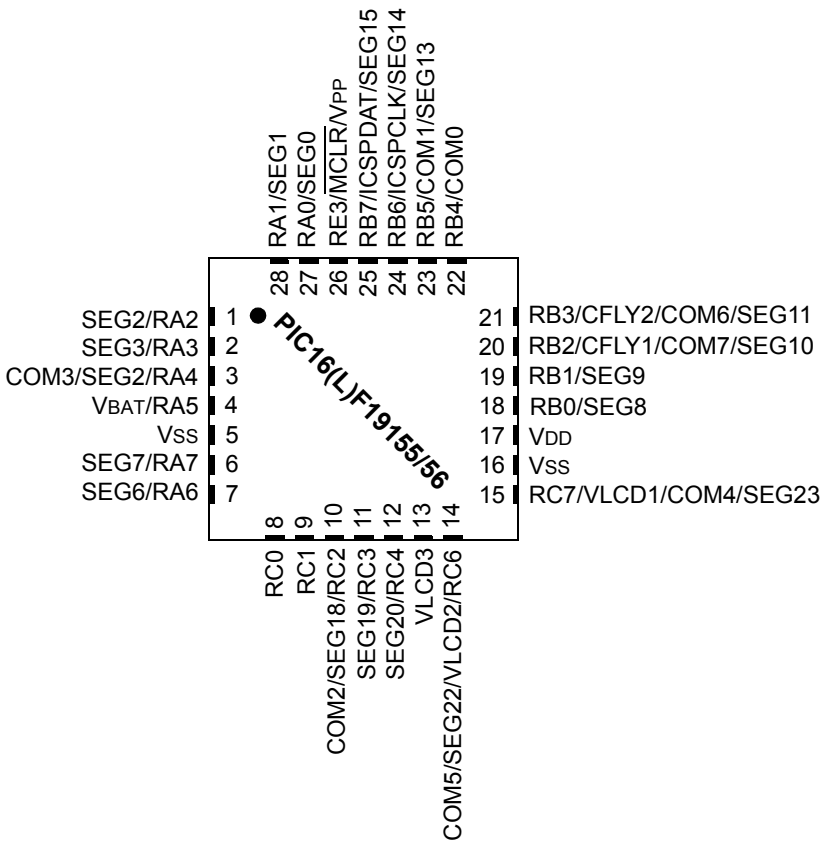
Note: Pin details are subject to change.

FIGURE 1: 28-PIN SSOP, SPDIP AND SOIC PIN DIAGRAM FOR PIC16(L)F19155/56



Note 1: See Table 3 for location of all peripheral functions.

FIGURE 2: 28-PIN UQFN PIN DIAGRAM FOR PIC16(L)F19155/56

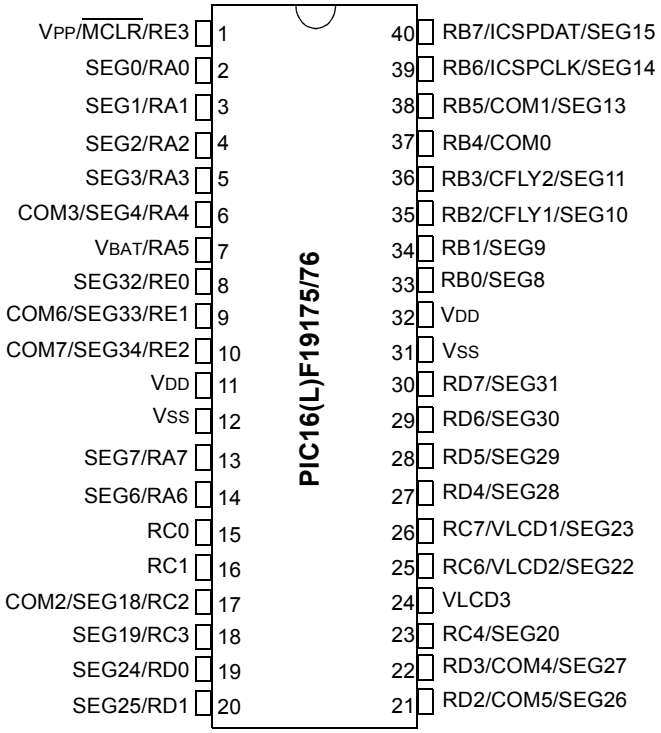


Note 1: See Table 3 for location of all peripheral functions.

2: All VDD and all VSS pins must be connected at the circuit board level. Allowing one or more VSS or VDD pins to float may result in degraded electrical performance or non-functionality.

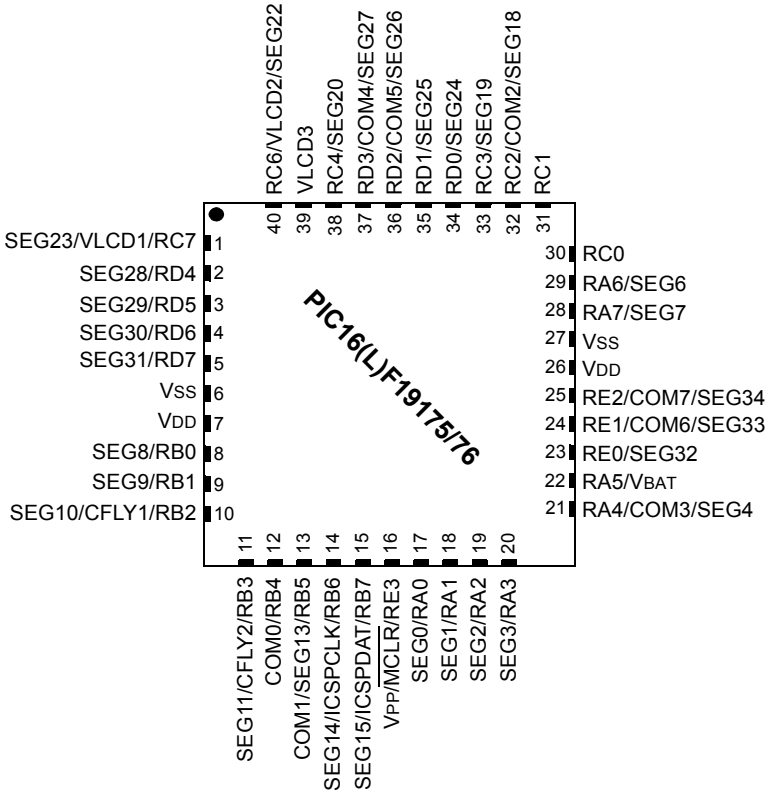
3: The bottom pad of the QFN/UQFN package should be connected to VSS at the circuit board level.

FIGURE 3: 40-PIN PDIP PIN DIAGRAM FOR PIC16(L)F19175/76



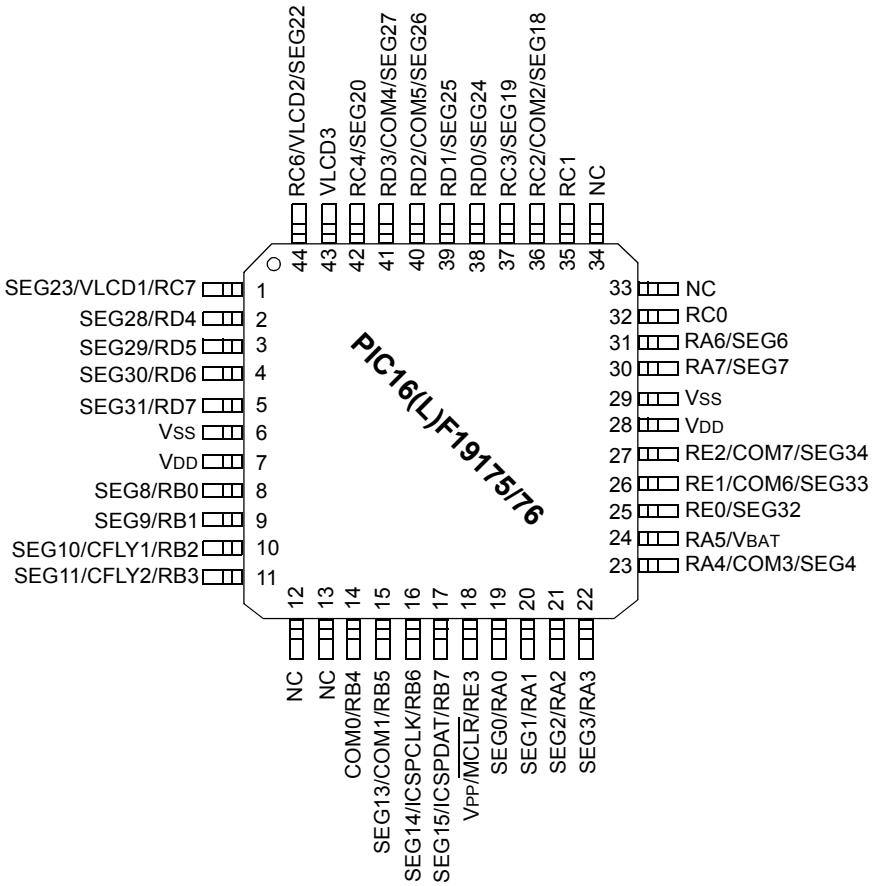
Note: See Table 4 for the pin allocation tables.

FIGURE 4: 40-PIN UQFN (5X5X0,5) PIN DIAGRAM FOR PIC16(L)F19175/76



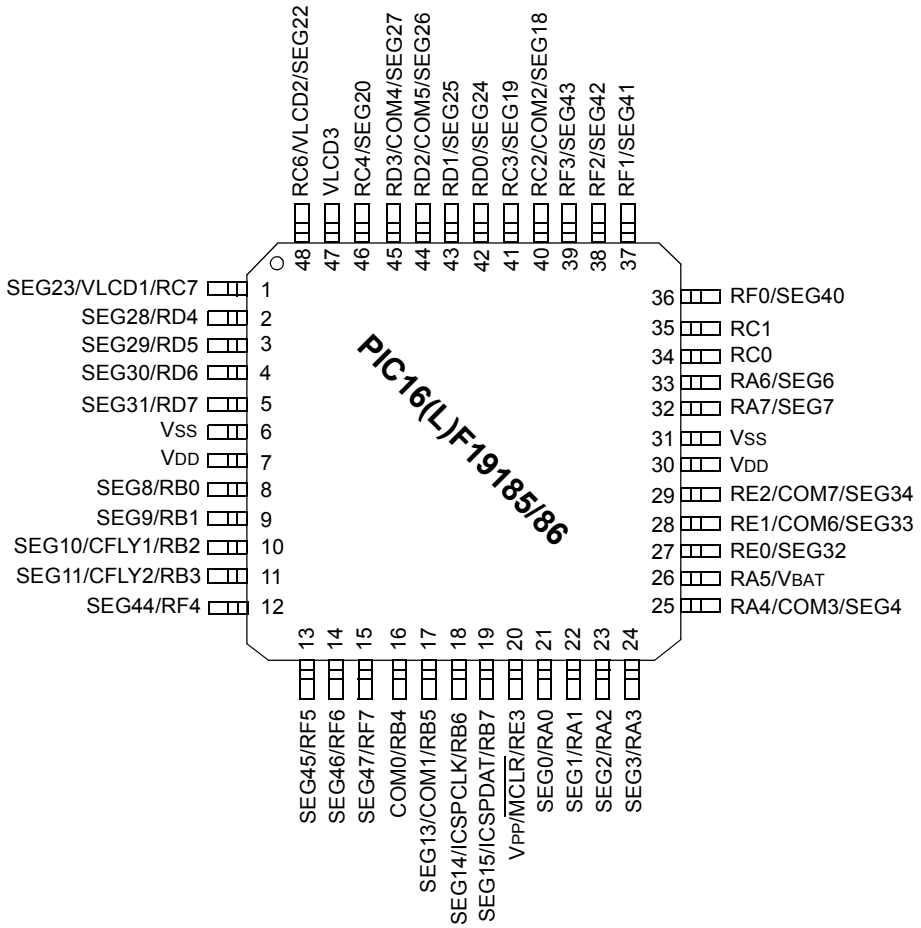
Note: See Table 4 for the pin allocation tables.

FIGURE 5: 44-PIN TQFP PIN DIAGRAM FOR PIC16(L)F19175/76



Note: See Table 4 for the pin allocation table.

FIGURE 6: 48-PIN TQFP/UQFN PIN DIAGRAM FOR PIC16(L)F19185/86



Note 1: See Table 5 for location of all peripheral functions.

2: QFN package orientation is the same. No leads are present on the QFN package.

PIN ALLOCATION TABLES

TABLE 3: 28-PIN ALLOCATION TABLE (PIC16(L)F19155/56)

I/O(2)	28-Pin SPDIP/SSOP/SOIC	28-Pin UQFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RA0	2	27	ANA0	—	C1IN0- C2IN0-	—	—	—	—	—	—	—	—	CLCIN0(1)	—	SEG0	IOCA0	—	Y	—
RA1	3	28	ANA1	—	C1IN1- C2IN1-	—	—	—	—	—	—	—	—	CLCIN1(1)	—	SEG1	IOCA1	—	—	—
RA2	4	1	ANA2	—	C1IN0+ C2IN0+	—	DAC1OUT1	—	—	—	—	—	—	—	—	SEG2	IOCA2	—	Y	—
RA3	5	2	ANA3	VREF+	C1IN1+	—	DAC1REF+	—	—	—	—	—	—	—	—	SEG3	IOCA3	—	Y	—
RA4	6	3	ANA4	—	—	—	—	T0CKI(1)	—	—	—	—	—	—	—	SEG4 COM3	IOCA4	—	Y	—
RA5	7	4	—	—	—	—	—	—	—	—	—	$\overline{SS}$(1)	—	—	—	—	IOCA5	—	Y	VBAT
RA6	10	7	ANA6	—	—	—	—	—	—	—	—	—	—	—	—	SEG6	IOCA6	—	Y	CLKOUT OSC2
RA7	9	6	ANA7	—	—	—	—	—	—	—	—	—	—	—	—	SEG7	IOCA7	—	Y	OSC1 CLKIN
RB0	21	18	ANB0	—	C2IN1+	ZCD	—	—	—	—	CWG1IN(1)	—	—	—	—	SEG8	IOCB0	—	Y	INTPPS
RB1	22	19	ANB1	—	C1IN3- C2IN3-	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG9	IOCB1	HIB1	Y	—
RB2	23	20	ANB2	—	—	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG10 COM7 CFLY1	IOCB2	—	Y	—
RB3	24	21	ANB3	—	C1IN2- C2IN2-	—	—	—	—	—	—	—	—	—	—	SEG11 COM6 CFLY2	IOCB3	—	Y	—
RB4	25	22	ANB4 ADCACT(1)	—	—	—	—	—	—	—	—	—	—	—	—	COM0	IOCB4	—	Y	—
RB5	26	23	ANB5	—	—	—	—	T1G(1)	—	—	—	—	—	—	—	SEG13 COM1	IOCB5	—	Y	—

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.
2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.
3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.
4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.
5: These are alternative I^2C logic levels pins.
6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 3: 28-PIN ALLOCATION TABLE (PIC16(L)F19155/56) (CONTINUED)

I/O(2)	28-Pin SPDIP/SSOP/SOIC	28-Pin UQFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RB6	27	24	ANB6	—	—	—	—	—	—	—	—	—	TX2(1) CK2(1)	CLCIN2(1)	—	SEG14	IOCB6	—	Y	ICDCLK/ ICSPCLK
RB7	28	25	ANB7	—	—	—	DAC1OUT2	—	—	—	—	—	RX2(1) DT2(1)	CLCIN3(1)	—	SEG15	IOCB7	—	Y	ICDDAT/ ICSPDAT
RC0	11	8	—	—	—	—	—	T1CKI(1) SMTWIN1(1)	—	—	—	—	—	—	—	—	IOCC0	—	Y	SOSCO
RC1	12	9	—	—	—	—	—	SMTSIG1(1) T4IN(1)	CCP2(1)	—	—	—	—	—	—	—	IOCC1	—	Y	SOSCI
RC2	13	10	ANC2	—	—	—	—	—	CCP1(1)	—	—	—	—	—	—	COM2 SEG18	IOCC2	—	Y	—
RC3	14	11	ANC3	—	—	—	—	T2IN(1)	—	—	—	SCK(1) SCL(1,3,4)	—	—	—	SEG19	IOCC3	—	Y	—
RC4	15	12	ANC4	—	—	—	—	—	—	—	—	SDI(1) SDA(1,3,4)	—	—	—	SEG20	IOCC4	—	Y	—
RC6	17	14	ANC6	—	—	—	—	—	—	—	—	—	TX1(1) CK1(1)	—	—	COM5 SEG22 VLCD2	IOCC6	—	Y	—
RC7	18	15	ANC7	—	—	—	—	—	—	—	—	—	RX1(1) DT1(1)	—	—	SEG23 COM4 VLCD1	IOCC7	—	Y	—
RE3	1	26	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCE3	—	Y	$\overline{MCLR}$
VLCD3	16	13	—	—	—	—	—	—	—	—	—	—	—	—	—	VLCD3	—	—	—	—
VDD	20	17	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	8 19	5 16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
OUT(2)	—	—	ADGRDA ADGRDB	—	C1OUT C2OUT	—	—	TMR0	CCP1 CCP2	PWM3 PWM4	CWG1A CWG1B CWG1C CWG1D	SDO SCK SCL SDA	TX1 DT1 CK1 TX2 DT2 CK2	CLC1OUT	RTCC	—	—	—	—	—

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.
2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.
3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.
4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.
5: These are alternative I^2C logic levels pins.
6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 4: 40/44-PIN ALLOCATION TABLE (PIC16(L)F19175/76)

I/O(2)	40-Pin PDIP	40-Pin UQFN	44-Pin TQFP	44-Pin QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RA0	2	17	19	19	ANA0	—	C1IN0- C2IN0-	—	—	—	—	—	—	—	—	CLCIN0(1)	—	SEG0	IOCA0	—	Y	—
RA1	3	18	20	20	ANA1	—	C1IN1- C2IN1-	—	—	—	—	—	—	—	—	CLCIN1(1)	—	SEG1	IOCA1	—	Y	—
RA2	4	19	21	21	ANA2	—	C1IN0+ C2IN0+	—	DAC1OUT1	—	—	—	—	—	—	—	—	SEG2	IOCA2	—	Y	—
RA3	5	20	22	22	ANA3	VREF+	C1IN1+	—	DAC1REF+	—	—	—	—	—	—	—	—	SEG3	IOCA3	—	Y	—
RA4	6	21	23	23	ANA4	—	—	—	—	T0CKI(1)	—	—	—	—	—	—	—	SEG4 COM3	IOCA4	—	Y	—
RA5	7	22	24	24	—	—	—	—	—	—	—	—	—	$\overline{SS}$(1)	—	—	—	—	IOCA5	—	—	VBAT
RA6	14	29	31	33	ANA6	—	—	—	—	—	—	—	—	—	—	—	—	SEG6	IOCA6	—	Y	CLKOUT OSC2
RA7	13	28	30	32	ANA7	—	—	—	—	—	—	—	—	—	—	—	—	SEG7	IOCA7	—	Y	OSC1 CLKIN
RB0	33	8	8	9	ANB0	—	C2IN1+	ZCD	—	—	—	—	CWG1IN(1)	—	—	—	—	SEG8	IOCB0	—	Y	INTPPS
RB1	34	9	9	10	ANB1	—	C1IN3- C2IN3-	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG9	IOCB1	HIB1	Y	—
RB2	35	10	10	11	ANB2	—	—	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG10 CFLY1	IOCB2	—	Y	—
RB3	36	11	11	12	ANB3	—	C1IN2- C2IN2-	—	—	—	—	—	—	—	—	—	—	SEG11 CFLY2	IOCB3	—	Y	—
RB4	37	12	14	14	ANB4 ADCACT(1)	—	—	—	—	—	—	—	—	—	—	—	—	COM0	IOCB4	—	Y	—
RB5	38	13	15	15	ANB5	—	—	—	—	T1G(1)	—	—	—	—	—	—	—	SEG13 COM1	IOCB5	—	Y	—
RB6	39	14	16	16	ANB6	—	—	—	—	—	—	—	—	—	TX2(1) CK2(1)	CLCIN2(1)	—	SEG14	IOCB6	—	Y	ICDCLK/ ICSPCLK
RB7	40	15	17	17	ANB7	—	—	—	DAC1OUT2	—	—	—	—	—	RX2(1) DT2(1)	CLCIN3(1)	—	SEG15	IOCB7	—	Y	ICDDAT/ ICSPDAT

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 4: 40/44-PIN ALLOCATION TABLE (PIC16(L)F19175/76) (CONTINUED)

I/O(2)	40-Pin PDIP	40-Pin UQFN	44-Pin TQFP	44-Pin QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RC0	15	30	32	34	—	—	—	—	—	T1CKI(1) SMTWIN1(1)	—	—	—	—	—	—	—	—	IOCC0	—	Y	SOSCO
RC1	16	31	35	35	—	—	—	—	—	SMTSIG1(1) T4IN(1)	CCP2(1)	—	—	—	—	—	—	—	IOCC1	—	Y	SOSCI
RC2	17	32	36	36	ANC2	—	—	—	—	—	CCP1(1)	—	—	—	—	—	—	COM2 SEG18	IOCC2	—	Y	—
RC3	18	33	37	37	ANC3	—	—	—	—	T2IN(1)	—	—	—	SCK(1) SCL(1,3,4)	—	—	—	SEG19	IOCC3	—	Y	—
RC4	23	38	42	42	ANC4	—	—	—	—	—	—	—	—	SDI(1) SDA(1,3,4)	—	—	—	SEG20	IOCC4	—	Y	—
RC6	25	40	44	44	ANC6	—	—	—	—	—	—	—	—	—	TX1(1) CK1(1)	—	—	SEG22 VLCD2	IOCC6	—	Y	—
RC7	26	1	1	1	ANC7	—	—	—	—	—	—	—	—	—	RX1(1) DT1(1)	—	—	SEG23 VLCD1	IOCC7	—	Y	—
RD0	19	34	38	38	AND0	—	—	—	—	—	—	—	—	—	—	—	—	SEG24	—	—	Y	—
RD1	20	35	39	39	AND1	—	—	—	—	—	—	—	—	—	—	—	—	SEG25	—	—	Y	—
RD2	21	36	40	40	AND2	—	—	—	—	—	—	—	—	—	—	—	—	COM5 SEG26	—	—	Y	—
RD3	22	37	41	41	AND3	—	—	—	—	—	—	—	—	—	—	—	—	COM4 SEG27	—	—	Y	—
RD4	27	2	2	2	AND4	—	—	—	—	—	—	—	—	—	—	—	—	SEG28	—	—	Y	—
RD5	28	3	3	3	AND5	—	—	—	—	—	—	—	—	—	—	—	—	SEG29	—	—	Y	—
RD6	29	4	4	4	AND6	—	—	—	—	—	—	—	—	—	—	—	—	SEG30	—	—	Y	—
RD7	30	5	5	5	AND7	—	—	—	—	—	—	—	—	—	—	—	—	SEG31	—	—	Y	—
RE0	8	23	25	25	ANE0	—	—	—	—	—	—	—	—	—	—	—	—	SEG32	—	—	Y	—
RE1	9	24	26	26	ANE1	—	—	—	—	—	—	—	—	—	—	—	—	COM6 SEG33	—	—	Y	—
RE2	10	25	27	27	ANE2	—	—	—	—	—	—	—	—	—	—	—	—	COM7 SEG34	—	—	Y	—
RE3	1	16	18	18	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCE3	—	Y	$\overline{MCLR}$

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 4: 40/44-PIN ALLOCATION TABLE (PIC16(L)F19175/76) (CONTINUED)

I/O(2)	40-Pin PDIP	40-Pin UQFN	44-Pin TQFP	44-Pin QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
VLCD3	24	39	43	43	—	—	—	—	—	—	—	—	—	—	—	—	—	VLCD3	—	—	—	—
VDD	11 32	7 26	7 28	7 28	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	12 31	6 27	6 29	6 30	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
OUT(2)	—	—	—	—	ADGRDA ADGRDB	—	C1OUT C2OUT	—	—	TMR0	CCP1 CCP2	PWM3 PWM4	CWG1A CWG1B CWG1C CWG1D	SDO SCK SCL SDA	TX1 DT1 CK1 TX2 DT2 CK2	CLC1OUT	RTCC	—	—	—	—	—

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 5: 48-PIN ALLOCATION TABLE (PIC16(L)F19185/86)

I/O(2)	48-Pin TQFP/QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RA0	21	ANA0	—	C1IN0- C2IN0-	—	—	—	—	—	—	—	—	CLCIN0(1)	—	SEG0	IOCA0	—	Y	—
RA1	22	ANA1	—	C1IN1- C2IN1-	—	—	—	—	—	—	—	—	CLCIN1(1)	—	SEG1	IOCA1	—	Y	—
RA2	23	ANA2	—	C1IN0+ C2IN0+	—	DAC1OUT1	—	—	—	—	—	—	—	—	SEG2	IOCA2	—	Y	—
RA3	24	ANA3	VREF+	C1IN1+	—	DAC1REF+	—	—	—	—	—	—	—	—	SEG3	IOCA3	—	Y	—
RA4	25	ANA4	—	—	—	—	T0CKI(1)	—	—	—	—	—	—	—	SEG4 COM3	IOCA4	—	Y	—
RA5	26	—	—	—	—	—	—	—	—	—	$\overline{SS}$(1)	—	—	—	—	IOCA5	—	Y	VBAT
RA6	33	ANA6	—	—	—	—	—	—	—	—	—	—	—	—	SEG6	IOCA6	—	Y	CLKOUT OSC2
RA7	32	ANA7	—	—	—	—	—	—	—	—	—	—	—	—	SEG7	IOCA7	—	Y	OSC1 CLKIN
RB0	8	ANB0	—	C2IN1+	ZCD	—	—	—	—	CWG1IN(1)	—	—	—	—	SEG8	IOCB0	—	Y	INTPPS
RB1	9	ANB1	—	C1IN3- C2IN3-	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG9	IOCB1	HIB1	Y	—
RB2	10	ANB2	—	—	—	—	—	—	—	—	SCL, SDA(1, 3, 4, 5, 6)	—	—	—	SEG10 CFLY1	IOCB2	—	Y	—
RB3	11	ANB3	—	C1IN2- C2IN2-	—	—	—	—	—	—	—	—	—	—	SEG11 CFLY2	IOCB3	—	Y	—
RB4	16	ANB4 ADCACT(1)	—	—	—	—	—	—	—	—	—	—	—	—	COM0	IOCB4	—	Y	—
RB5	17	ANB5	—	—	—	—	T1G(1)	—	—	—	—	—	—	—	SEG13 COM1	IOCB5	—	Y	—
RB6	18	ANB6	—	—	—	—	—	—	—	—	—	TX2(1) CK2(1)	CLCIN2(1)	—	SEG14	IOCB6	—	Y	ICDCLK/ ICSPCLK
RB7	19	ANB7	—	—	—	DAC1OUT2	—	—	—	—	—	RX2(1) DT2(1)	CLCIN3(1)	—	SEG15	IOCB7	—	Y	ICDDAT/ ICSPDAT

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 5: 48-PIN ALLOCATION TABLE (PIC16(L)F19185/86) (CONTINUED)

I/O(2)	48-Pin TQFP/QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RC0	34	—	—	—	—	—	T1CKI(1) SMTWIN1(1)	—	—	—	—	—	—	—	—	IOCC0	—	Y	SOSCO
RC1	35	—	—	—	—	—	SMTSIG1(1) T4IN(1)	CCP2(1)	—	—	—	—	—	—	—	IOCC1	—	Y	SOSCI
RC2	40	ANC2	—	—	—	—	—	CCP1(1)	—	—	—	—	—	—	COM2 SEG18	IOCC2	—	Y	—
RC3	41	ANC3	—	—	—	—	T2IN(1)	—	—	—	SCK(1) SCL(1,3,4)	—	—	—	SEG19	IOCC3	—	Y	—
RC4	46	ANC4	—	—	—	—	—	—	—	—	SDI(1) SDA(1,3,4)	—	—	—	SEG20	IOCC4	—	Y	—
RC6	48	ANC6	—	—	—	—	—	—	—	—	—	TX1(1) CK1(1)	—	—	SEG22 VLCD2	IOCC6	—	Y	—
RC7	1	ANC7	—	—	—	—	—	—	—	—	—	RX1(1) DT1(1)	—	—	SEG23 VLCD1	IOCC7	—	Y	—
RD0	42	AND0	—	—	—	—	—	—	—	—	—	—	—	—	SEG24	—	—	Y	—
RD1	43	AND1	—	—	—	—	—	—	—	—	—	—	—	—	SEG25	—	—	Y	—
RD2	44	AND2	—	—	—	—	—	—	—	—	—	—	—	—	COM5 SEG26	—	—	Y	—
RD3	45	AND3	—	—	—	—	—	—	—	—	—	—	—	—	COM4 SEG27	—	—	Y	—
RD4	2	AND4	—	—	—	—	—	—	—	—	—	—	—	—	SEG28	—	—	Y	—
RD5	3	AND5	—	—	—	—	—	—	—	—	—	—	—	—	SEG29	—	—	Y	—
RD6	4	AND6	—	—	—	—	—	—	—	—	—	—	—	—	SEG30	—	—	Y	—
RD7	5	AND7	—	—	—	—	—	—	—	—	—	—	—	—	SEG31	—	—	Y	—
RE0	27	ANE0	—	—	—	—	—	—	—	—	—	—	—	—	SEG32	—	—	Y	—
RE1	28	ANE1	—	—	—	—	—	—	—	—	—	—	—	—	COM6 SEG33	—	—	Y	—
RE2	29	ANE2	—	—	—	—	—	—	—	—	—	—	—	—	COM7 SEG34	—	—	Y	—
RE3	20	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCE3	—	Y	$\overline{\text{MCLR}}$

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.
2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.
3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.
4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.
5: These are alternative I^2C logic levels pins.
6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

TABLE 5: 48-PIN ALLOCATION TABLE (PIC16(L)F19185/86) (CONTINUED)

I/O(2)	48-Pin TQFP/QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RF0	36	ANF0	—	—	—	—	—	—	—	—	—	—	—	—	SEG40	—	—	Y	—
RF1	37	ANF1	—	—	—	—	—	—	—	—	—	—	—	—	SEG41	—	—	Y	—
RF2	38	ANF2	—	—	—	—	—	—	—	—	—	—	—	—	SEG42	—	—	Y	—
RF3	39	ANF3	—	—	—	—	—	—	—	—	—	—	—	—	SEG43	—	—	Y	—
RF4	12	ANF4	—	—	—	—	—	—	—	—	—	—	—	—	SEG44	—	—	Y	—
RF5	13	ANF5	—	—	—	—	—	—	—	—	—	—	—	—	SEG45	—	—	Y	—
RF6	14	ANF6	—	—	—	—	—	—	—	—	—	—	—	—	SEG46	—	—	Y	—
RF7	15	ANF7	—	—	—	—	—	—	—	—	—	—	—	—	SEG47	—	—	Y	—
VLCD3	47	—	—	—	—	—	—	—	—	—	—	—	—	—	VLCD3	—	—	Y	—
VDD	7 30	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	Y	VDD
VSS	6 31	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	Y	VSS
OUT(2)	—	ADGRDA ADGRDB	—	C1OUT C2OUT	—	—	TMR0	CCP1 CCP2	PWM3 PWM4	CWG1A CWG1B CWG1C CWG1D	SDO SCK SCL SDA	TX1 DT1 CK1 TX2 DT2 CK2	CLC1OUT	RTCC	—	—	—	—	—

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by INLCVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL and SDA pins.

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1.0 DEVICE OVERVIEW

The PIC16(L)F19155/56/75/76/85/86 are described within this data sheet. The PIC16(L)F19155/56/75/76/85/86 devices are available in 48-pin TQFP and UQFN, 44-pin TQFP and UQFN, 40-pin PDIP and 28-pin SPDIP, SOIC, SSOP and UQFN packages. Figure 1-1 shows a block diagram of the PIC16(L)F19155/56/75/76/85/86 devices. Table 1-2 shows the pinout descriptions.

Reference Table 1-1 for peripherals available per device.

TABLE 1-1: DEVICE PERIPHERAL SUMMARY

Peripheral		PIC16(L)F19155/56/75/76/85/86
Analog-to-Digital Converter with Computation (ADC^2)		•
Digital-to-Analog Converter (DAC1)		•
Fixed Voltage Reference (FVR)		•
Enhanced Universal Synchronous/Asynchronous Receiver/ Transmitter (EUSART1 and EUSART2)		•
Temperature Indicator Module (TIM)		•
Zero-Cross Detect (ZCD1)		•
Real-Time Calendar and Clock (RTCC)		•
Liquid Crystal Display (LCD)		•
Capture/Compare/PWM Modules (CCP)		
	CCP1	•
	CCP2	•
Comparator Module (Cx)		
	C1	•
	C2	•
Configurable Logic Cell (CLC)		
	CLC1	•
	CLC2	•
	CLC3	•
	CLC4	•
Complementary Waveform Generator (CWG)		
	CWG1	•
Master Synchronous Serial Ports (MSSP)		
	MSSP1	•
Pulse-Width Modulator (PWM)		
	PWM3	•
	PWM4	•
Signal Measure Timer (SMT)		
	SMT1	•
Timers		
	Timer0	•
	Timer1	•
	Timer2	•
	Timer4	•

1.1 Register and Bit Naming Conventions

1.1.1 REGISTER NAMES

When there are multiple instances of the same peripheral in a device, the peripheral control registers will be depicted as the concatenation of a peripheral identifier, peripheral instance, and control identifier. The control registers section will show just one instance of all the register names with an 'x' in the place of the peripheral instance number. This naming convention may also be applied to peripherals when there is only one instance of that peripheral in the device to maintain compatibility with other devices in the family that contain more than one.

1.1.2 BIT NAMES

There are two variants for bit names:

- Short name: Bit function abbreviation
- Long name: Peripheral abbreviation + short name

1.1.2.1 Short Bit Names

Short bit names are an abbreviation for the bit function. For example, some peripherals are enabled with the EN bit. The bit names shown in the registers are the short name variant.

Short bit names are useful when accessing bits in C programs. The general format for accessing bits by the short name is *RegisterName*bits.*ShortName*. For example, the enable bit, EN, in the COG1CON0 register can be set in C programs with the instruction `COG1CON0bits.EN = 1`.

Short names are generally not useful in assembly programs because the same name may be used by different peripherals in different bit positions. When this occurs, during the include file generation, all instances of that short bit name are appended with an underscore plus the name of the register in which the bit resides to avoid naming contentions.

1.1.2.2 Long Bit Names

Long bit names are constructed by adding a peripheral abbreviation prefix to the short name. The prefix is unique to the peripheral, thereby making every long bit name unique. The long bit name for the COG1 enable bit is the COG1 prefix, G1, appended with the enable bit short name, EN, resulting in the unique bit name G1EN.

Long bit names are useful in both C and assembly programs. For example, in C the COG1CON0 enable bit can be set with the `G1EN = 1` instruction. In assembly, this bit can be set with the `BSF COG1CON0,G1EN` instruction.

1.1.2.3 Bit Fields

Bit fields are two or more adjacent bits in the same register. Bit fields adhere only to the short bit naming convention. For example, the three Least Significant bits of the COG1CON0 register contain the mode control bits. The short name for this field is MD. There is no long bit name variant. Bit field access is only possible in C programs. The following example demonstrates a C program instruction for setting the COG1 to the Push-Pull mode:

```
COG1CON0bits.MD = 0x5;
```

Individual bits in a bit field can also be accessed with long and short bit names. Each bit is the field name appended with the number of the bit position within the field. For example, the Most Significant mode bit has the short bit name MD2 and the long bit name is G1MD2. The following two examples demonstrate assembly program sequences for setting the COG1 to Push-Pull mode.

EXAMPLE 1-1: ASSEMBLY SEQUENCE 1 FOR SETTING COG1 TO PUSH-PULL MODE

```
MOVLW  ~(1<<G1MD1)
ANDWF  COG1CON0,F
MOVLW  1<<G1MD2 | 1<<G1MD0
IORWF  COG1CON0,F
```

EXAMPLE 1-2: ASSEMBLY SEQUENCE 2 FOR SETTING COG1 TO PUSH-PULL MODE

```
BSF    COG1CON0,G1MD2
BCF    COG1CON0,G1MD1
BSF    COG1CON0,G1MD0
```

1.1.3 REGISTER AND BIT NAMING EXCEPTIONS

1.1.3.1 Status, Interrupt, and Mirror Bits

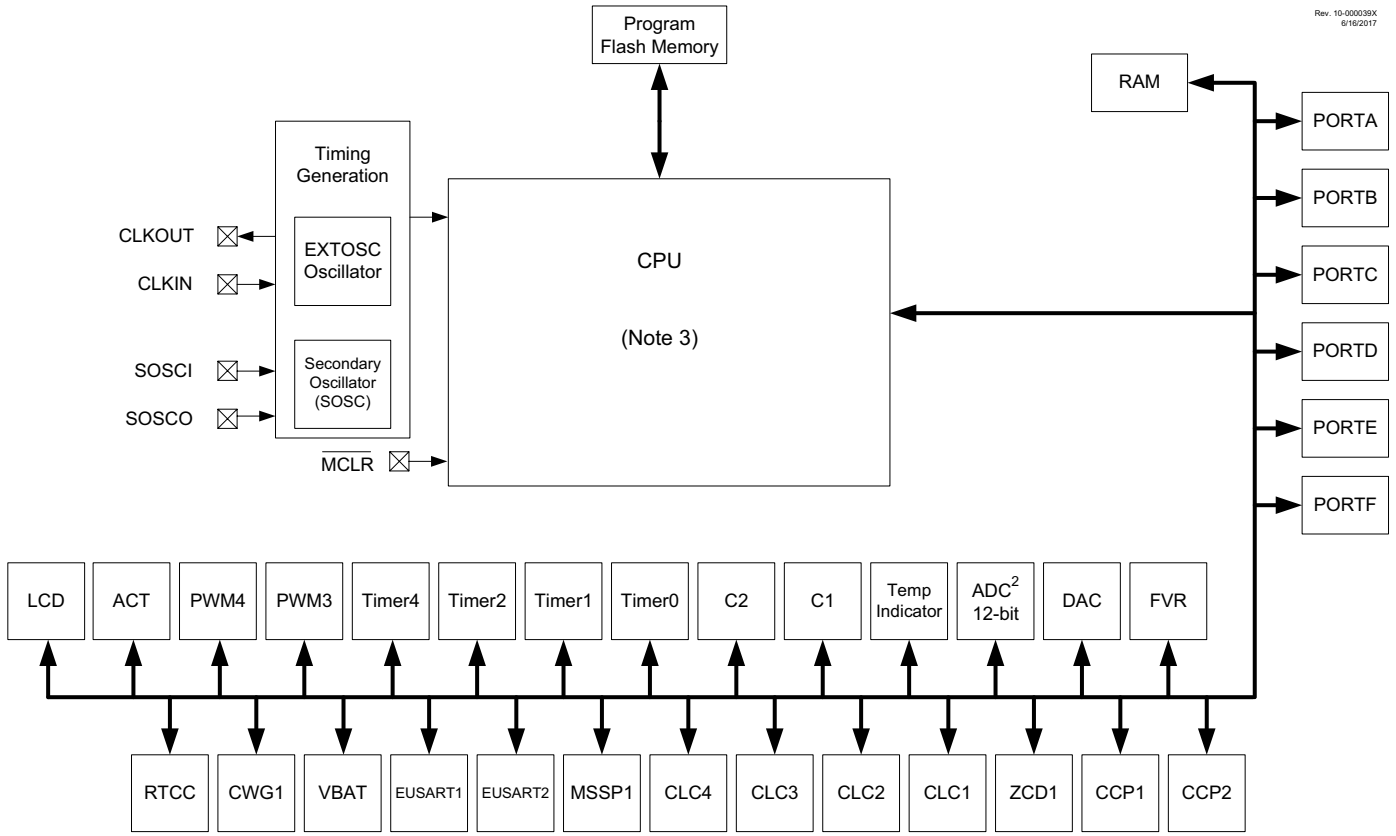
Status, interrupt enables, interrupt flags, and mirror bits are contained in registers that span more than one peripheral. In these cases, the bit name shown is unique so there is no prefix or short name variant.

1.1.3.2 Legacy Peripherals

There are some peripherals that do not strictly adhere to these naming conventions. Peripherals that have existed for many years and are present in almost every device are the exceptions. These exceptions were necessary to limit the adverse impact of the new conventions on legacy code. Peripherals that do adhere to the new convention will include a table in the registers section indicating the long name prefix for each peripheral instance. Peripherals that fall into the exception category will not have this table. These peripherals include, but are not limited to, the following:

- EUSART
- MSSP

FIGURE 1-1: PIC16(L)F19155/56/75/76/85/86 BLOCK DIAGRAM



Note 1: See applicable chapters for more information on peripherals.

2: See Table 1-1 for peripherals available on specific devices.

3: See Figure 3-1.

TABLE 1-2: PIC16(L)F19155/56 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/C1IN0-/C2IN0-/ANA0/CLCIN0(1)/IOCA0/SEG0	RA0	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN0-	AN		Comparator negative input.
	C2IN0-	AN		Comparator negative input.
	ANA0	AN		ADC Channel input.
	CLCIN0(1)	—		Configurable Logic Cell source input.
	IOCA0	TTL/ST		Interrupt-on-change input.
	SEG0	—	AN	LCD Analog output.
RA1/C1IN1-/C2IN1-/ANA1/CLCIN1(1)/SEG1	RA1	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN1-	AN		Comparator negative input.
	C2IN1-	AN		Comparator negative input.
	ANA1	AN		ADC Channel input.
	CLCIN1(1)	—		Configurable Logic Cell source input.
	IOCA1	TTL/ST		Interrupt-on-change input.
	SEG1	—	AN	LCD Analog output.
RA2/C1IN0+/C2IN0+/ANA2/DAC1OUT1/IOCA2/SEG2	RA2	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN0+	AN	—	Comparator positive input.
	C2IN0+	AN	—	Comparator positive input.
	ANA2	AN	—	ADC Channel input.
	DAC1OUT1	—	AN	Digital-to-Analog Converter output.
	IOCA2	TTL/ST	—	Interrupt-on-change input.
	SEG2	—	AN	LCD Analog output.
RA3/C1IN1+/ANA3/SEG3/IOCA3/VREF+ (ADC)/VREF+ (DAC1)	RA3	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN1+	AN	—	Comparator positive input.
	ANA3	AN	—	ADC Channel input.
	SEG3	—	AN	LCD Analog output.
	IOCA3	TTL/ST	—	Interrupt-on-change input.
	VREF+ (ADC)	AN	—	ADC positive reference.
	VREF+ (DAC1)	AN	—	DAC positive reference.
RA4/ANA4/T0CKI(1)/IOCA4/SEG4/COM3	RA4	TTL/ST	CMOS/OD	General purpose I/O.
	ANA4	AN	—	ADC Channel input.
	T0CKI(1)	—	—	Timer0 clock input.
	IOCA4	TTL/ST	—	Interrupt-on-change input.
	SEG4	—	AN	LCD Analog output.
	COM3	—	AN	LCD Driver Common Outputs.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open-Drain
TTL = TTL compatible input‘; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C
HV = High Voltage; XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 14-2 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 14-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

TABLE 1-2: PIC16(L)F19155/56 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RA5/SS(1)/IOCA5/VBAT	RA5	TTL/ST	CMOS/OD	General purpose I/O.
	SS(1)	—	—	MSSP SPI slave select input.
	IOCA5	TTL/ST	—	Interrupt-on-change input.
	VBAT	AN	—	RTCC Back-up Battery.
RA6/ANA6/IOCA6/SEG6/CLKOUT	RA6	TTL/ST	CMOS/OD	General purpose I/O.
	ANA6	AN	—	ADC Channel input.
	IOCA6	—	—	Interrupt-on-change input.
	SEG6	—	AN	LCD Analog output.
	CLKOUT	TTL/ST	—	FOSC/4 digital output.
RA7/ANA7/SEG7/CLKIN	RA7	TTL/ST	CMOS/OD	General purpose I/O.
	ANA7	AN	—	ADC Channel input.
	SEG7	—	AN	LCD Analog output.
	CLKIN	ST	—	External Clock driver input.
RB0/CWG1IN(1)/C2IN1+/IOCB0/ANB0/SEG8/ZCD	RB0	TTL/ST	CMOS/OD	General purpose I/O.
	CWG1IN(1)	TTL/ST	—	Complementary Waveform Generator input
	C2IN1+	AN	—	Comparator positive input.
	IOCB0	TTL/ST	—	Interrupt-on-change input.
	ANB0	AN	—	ADC Channel input.
	SEG8	-	AN	LCD Analog output.
	ZCD	AN	—	Zero-cross detect input pin (with constant current sink/source).
RB1/C1IN3-/C2IN3-/IOCB1/SCL(3,4)/SCK(1)/ANB1/HIB1/SEG9	RB1	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN3-	AN	—	Comparator negative input.
	C2IN3-	AN	—	Comparator negative input.
	IOCB1	TTL/ST	—	Interrupt-on-change input.
	SCL(3,4)	I2C	OD	MSSP I2Cclock input/output.
	SCK(1)	TTL/ST	—	MSSP SPI clock input/output.
	ANB1	AN	—	ADC Channel input.
	HIB1	TTL/ST	—	High current output.
	SEG9	—	AN	LCD Analog output.
RB2/IOCB2/SDA(3,4)/SDI(1)/ANB2/SEG10/COM7/SEGCFLY1	RB2	TTL/ST	CMOS/OD	General purpose I/O.
	IOCB2	TTL/ST	—	Interrupt-on-change input.
	SDA(3,4)	I2C	OD	MSSP I2C data input/output.
	SDI(1)	TTL/ST	—	MSSP SPI serial data in.
	ANB2	AN	—	ADC Channel input.
	SEG10	—	AN	LCD Analog output.
	COM7	—	AN	LCD Driver Common Outputs.
	SEGCFLY1	AN	—	LCD Drive Charge Pump Capacitor Inputs

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open-Drain
TTL = TTL compatible input‘; ST = Schmitt Trigger input with CMOS levels; I2C = Schmitt Trigger input with I2C
HV = High Voltage; XTAL = Crystal levels

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TABLE 1-2: PIC16(L)F19155/56 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB3/C1IN2-/C2IN2-/IOCB3/ANB3/SEG11/COM6/ SEGCFLY2	RB3	TTL/ST	CMOS/OD	General purpose I/O.
	C1IN2-	AN	—	Comparator negative input.
	C2IN2-	AN	—	Comparator negative input.
	IOCB3	TTL/ST	—	Interrupt-on-change input.
	ANB3	AN	—	ADC Channel input.
	SEG11	—	AN	LCD Analog output.
	COM6	—	AN	LCD Driver Common Outputs.
	SEGCFLY2	AN	—	LCD Drive Charge Pump Capacitor Inputs
RB4/ADCACT(1)/IOCB4/ANB4/COM0	RB4	TTL/ST	CMOS/OD	General purpose I/O.
	ADCACT(1)	TTL/ST	—	ADC Auto-Conversion Trigger input
	IOCB4	TTL/ST	—	Interrupt-on-change input.
	ANB4	AN	—	ADC Channel input.
	COM0	—	AN	LCD Driver Common Outputs.
RB5/T1G(1)/IOCB5/ANB5/SEG13/COM1	RB5	TTL/ST	CMOS/OD	General purpose I/O.
	T1G(1)	—	—	Timer1 Gate input.
	IOCB5	TTL/ST	—	Interrupt-on-change input.
	ANB5	AN	—	ADC Channel input.
	SEG13	—	AN	LCD Analog output.
	COM1	—	AN	LCD Driver Common Outputs.
RB6/CK2(3)/TX2(1)/CLCIN2(1)/IOCB6/ANB6/SEG14/ ICSPCLK	RB6	TTL/ST	CMOS/OD	General purpose I/O.
	CK2(3)	—	—	EUSART synchronous clock out
	TX2(1)	—	—	EUSART asynchronous TX data out
	CLCIN2(1)	—	—	Configurable Logic Cell source input.
	IOCB6	TTL/ST	—	Interrupt-on-change input.
	ANB6	AN	—	ADC Channel input.
	SEG14	—	AN	LCD Analog output.
	ICSPCLK	ST	—	In-Circuit Serial Programming™ and debugging clock input.
RB7/DK2(3)/RX2(1)/CLCIN3(1)/IOCB7/ANB7/SEG15/ DAC1OUT2/ICSPDAT	RB7	TTL/ST	CMOS/OD	General purpose I/O.
	DK2(3)	—	—	EUSART synchronous data output
	RX2(1)	—	—	EUSART receive input.
	CLCIN3(1)	—	—	Configurable Logic Cell source input.
	IOCB7	TTL/ST	—	Interrupt-on-change input.
	ANB7	AN	—	ADC Channel input.
	SEG15	—	AN	LCD Analog output.
	DAC1OUT2	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	TTL/ST	TTL/ST	In-Circuit Serial Programming™ and debugging data input/output.

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TABLE 1-2: PIC16(L)F19155/56 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC0/T1CKI(1)/SMTWIN1(1)/IOCC0/SOSCO	RC0	TTL/ST	CMOS/OD	General purpose I/O.
	T1CKI(1)	—	—	Timer1 clock input.
	SMTWIN1(1)	—	—	SMT window input.
	IOCC0	TTL/ST	—	Interrupt-on-change input.
	SOSCO	#VALUE!	AN	32.768 kHz secondary oscillator crystal driver output.
RC1/T4IN(1)/SMTSIG1(1)/CCP2(1)/IOCC1/SOSCI	RC1	TTL/ST	CMOS/OD	General purpose I/O.
	T4IN(1)	—	—	Timer4 external input.
	SMTSIG1(1)	—	—	SMT signal input.
	CCP2(1)	—	—	CCP Capture Input.
	IOCC1	TTL/ST	—	Interrupt-on-change input.
	SOSCI	—	—	32.768 kHz secondary oscillator crystal driver input.
RC2/CCP1(1)/IOCC2/ANC2/SEG18/COM2	RC2	TTL/ST	CMOS/OD	General purpose I/O.
	CCP1(1)	—	—	CCP Capture Input.
	IOCC2	TTL/ST	—	Interrupt-on-change input.
	ANC2	AN	—	ADC Channel input.
	SEG18	—	AN	LCD Analog output.
	COM2	—	AN	LCD Driver Common Outputs.
RC3/T2IN/SCL(3,4)/SCK(1)/SEG19	RC3	TTL/ST	CMOS/OD	General purpose I/O.
	T2IN(1)	—	—	Timer2 external input.
	SCL(3,4)	I^2C	OD	MSSP I^2Cclock input/output.
	SCK(1)	TTL/ST	—	MSSP SPI clock input/output
	IOCC3	TTL/ST	—	Interrupt-on-change input.
	ANC3	AN	—	ADC Channel input.
	SEG19	—	AN	LCD Analog output.
RC4/SDA(3,4)/SDI(1)/IOCC4/ANC4/SEG20	RC4	TTL/ST	CMOS/OD	General purpose I/O.
	SDA(3,4)	TTL/ST	—	MSSP I^2C data input/output.
	SDI(1)	I^2C	OD	MSSP SPI serial data in.
	IOCC4	TTL/ST	—	Interrupt-on-change input.
	ANC4	AN	—	ADC Channel input.
	SEG20	—	AN	LCD Analog output.
RC6/CK1(3)/TX1(1)/IOCC6/ANC6/SEG22/COM5/VLCD2	RC6	TTL/ST	CMOS/OD	General purpose I/O.
	CK1(3)	—	—	EUSART synchronous clock out
	TX1(1)	—	—	EUSART asynchronous TX data out
	IOCC6	TTL/ST	—	Interrupt-on-change input.
	ANC6	AN	—	ADC Channel input.
	SEG22	—	AN	LCD Analog output.
	COM5	—	AN	LCD Driver Common Outputs.
	VLCD2	AN	—	LCD analog input

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